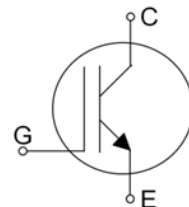
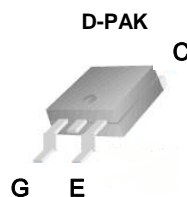


**Features:**

- 400V Trench Technology
- High Speed Switching
- Low Conduction Loss
- Positive Temperature Coefficient
- Easy parallel Operation
- RoHS compliant
- JEDEC Qualification


**Applications :**

Plasma Display Panel, Soft switching application,

Device	Package	Packaging type	Marking	Remark
TGD30N40P	D-PAK	Reel	TGD30N40P	RoHS

**Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CES}$	400	V
Gate-Emitter Voltage	$V_{GES}$	$\pm 30$	V
Continuous Current	$I_c$	$T_C = 25\text{ }^\circ\text{C}$	60
		$T_C = 100\text{ }^\circ\text{C}$	30
Pulsed Collector Current (Note 1)	$I_{CM}$	300	A
Power Dissipation	$P_D$	$T_C = 25\text{ }^\circ\text{C}$	56.8
		$T_C = 100\text{ }^\circ\text{C}$	22.7
Operating Junction Temperature	$T_J$	-55 ~ 150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 ~ 150	$^\circ\text{C}$
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	$T_L$	300	$^\circ\text{C}$

Notes :

 (1) Repetitive rating : Pulse width limited by max junction temperature,  $PW \leq 10\mu\text{s}$ , duty cycle  $\leq 1\%$ .

**Thermal Characteristics**

Parameter	Symbol	Value	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$	2.2	$^\circ\text{C}/\text{W}$
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	110	$^\circ\text{C}/\text{W}$

**Electrical Characteristics of the IGBT**  $T_C=25^{\circ}\text{C}$ , unless otherwise noted

Parameter	Symbol	Test condition	Min	Typ	Max	Units
<b>OFF</b>						
Collector – Emitter Breakdown Voltage	$BV_{CES}$	$V_{GE} = 0V, I_C = 1mA$	400	--	--	V
Zero Gate Voltage Collector Current	$I_{CES}$	$V_{CE} = 400V, V_{GE} = 0V$	--	--	100	$\mu A$
Gate – Emitter Leakage Current	$I_{GES}$	$V_{CE} = 0V, V_{GE} = \pm 30V$	--	--	$\pm 250$	nA

<b>ON</b>						
Gate – Emitter Threshold Voltage	$V_{GE(TH)}$	$V_{GE} = V_{CE}, I_C = 1mA$	2	3.1	4.5	V
Collector – Emitter Saturation Voltage	$V_{CE(SAT)}$	$V_{GE} = 15V, I_C = 30A, T_J = 25^{\circ}\text{C}$	--	1.4	2.0	V
		$V_{GE} = 15V, I_C = 30A, T_J = 125^{\circ}\text{C}$	--	1.52	--	V

<b>DYNAMIC</b>						
Input Capacitance	$C_{IES}$	$V_{CE} = 25V,$ $V_{GE} = 0V,$ $f = 1MHz$	--	845	--	pF
Output Capacitance	$C_{OES}$		--	50	--	pF
Reverse Transfer Capacitance	$C_{RES}$		--	23	--	pF

<b>SWITCHING</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 150V, I_C = 30A,$ $R_G = 5\Omega, V_{GE} = 15V,$ Resistive Load, $T_J = 25^{\circ}\text{C}$	--	13	--	ns
Rise Time	$t_r$		--	105	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	35	--	ns
Fall Time	$t_f$		--	160	--	ns
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 150V, I_C = 30A,$ $R_G = 5\Omega, V_{GE} = 15V,$ Resistive Load, $T_J = 125^{\circ}\text{C}$	--	14	--	ns
Rise Time	$t_r$		--	145	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	40	--	ns
Fall Time	$t_f$		--	240	--	ns
Total Gate Charge	$Q_g$	$V_{CC} = 150V, I_C = 30A,$ $V_{GE} = 15V$	--	26	--	nC
Gate-Emitter Charge	$Q_{ge}$		--	3.1	--	nC
Gate-Collector Charge	$Q_{gc}$		--	9	--	nC

Fig. 1 Output characteristics

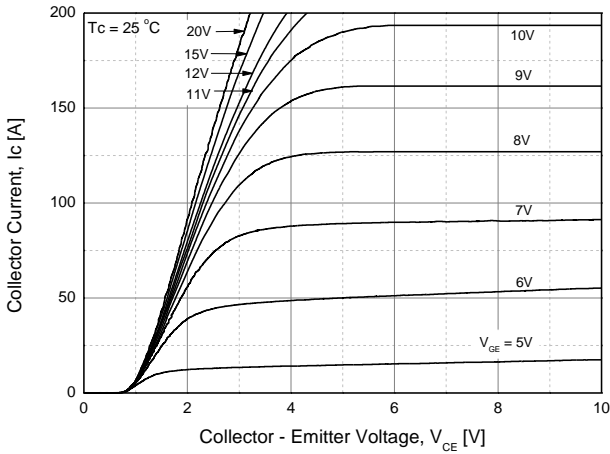


Fig. 2 Saturation voltage characteristics

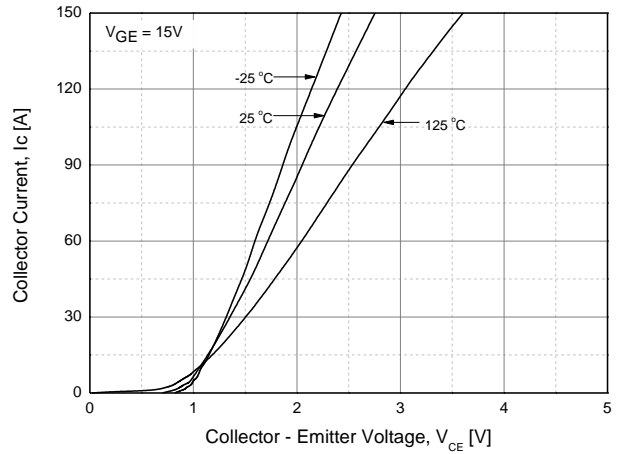


Fig. 3 Saturation voltage vs. collector current

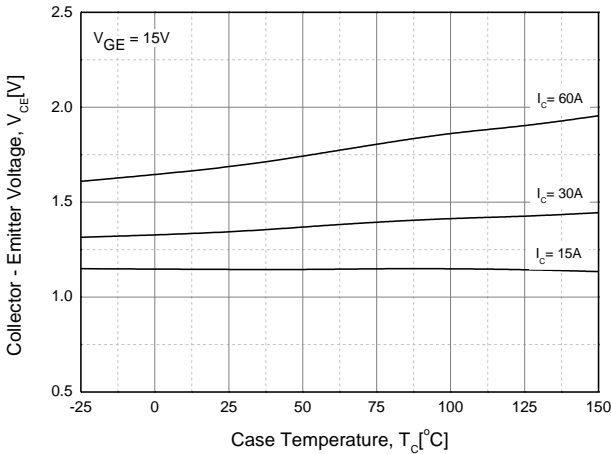


Fig. 4 Saturation voltage vs. gate bias

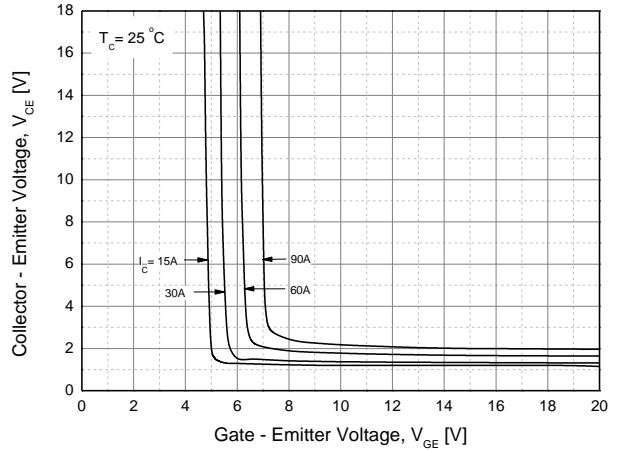


Fig. 5 Saturation voltage vs. gate bias

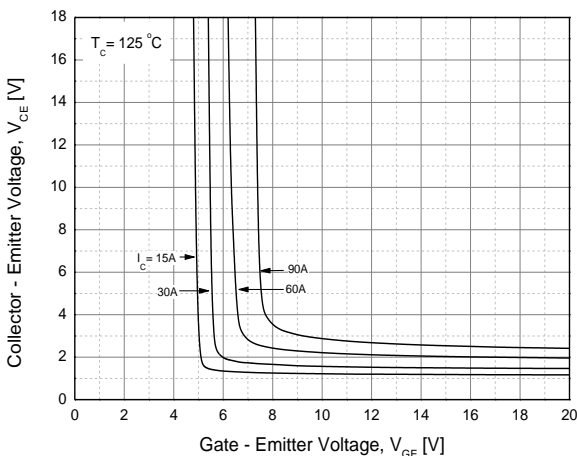


Fig. 6 Capacitance characteristics

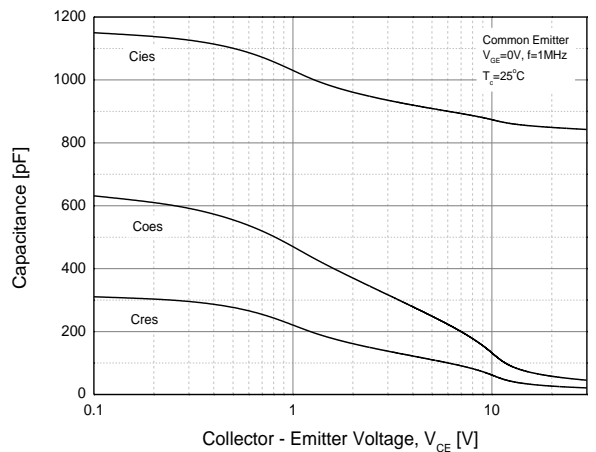


Fig. 7 Turn on time vs. gate resistance

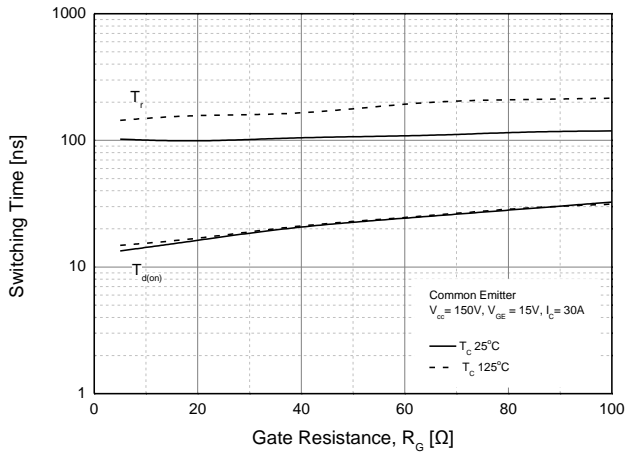


Fig. 8 Turn on time vs. collector current

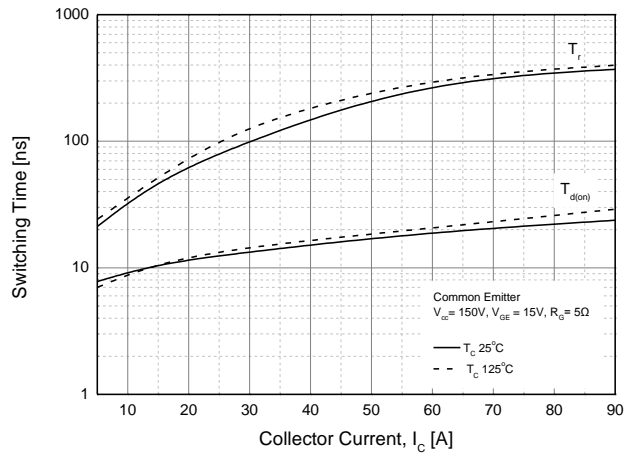


Fig. 9 Turn on time vs. Case temperature

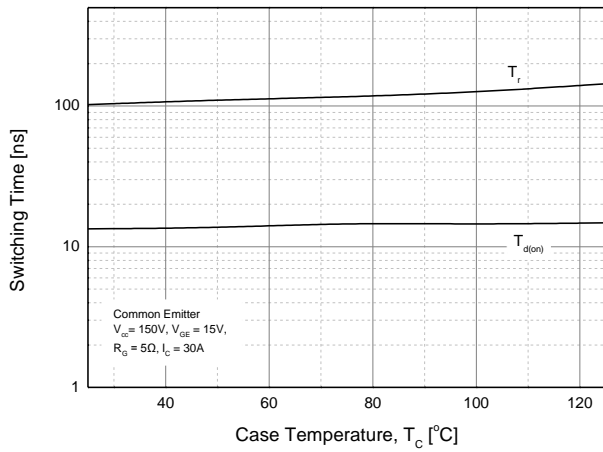


Fig. 10 Turn off time vs. gate resistance

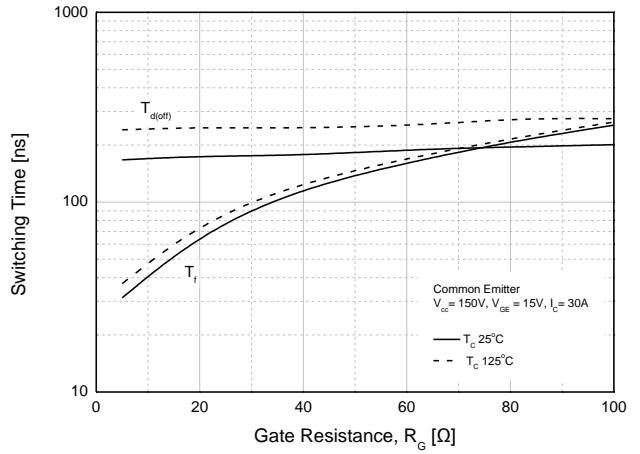


Fig. 11 Turn off time vs. collector current

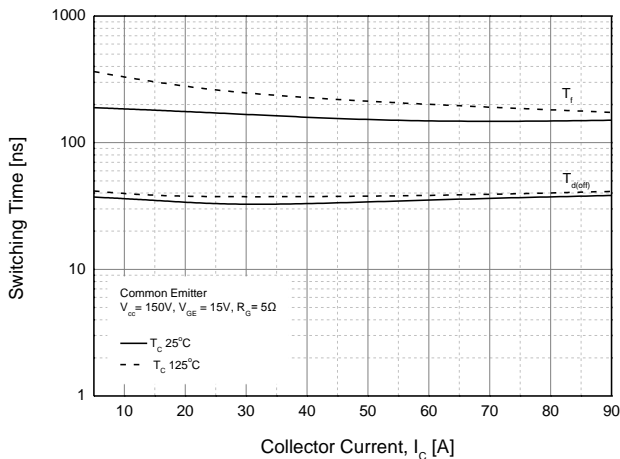


Fig. 12 Turn off time vs. Case temperature

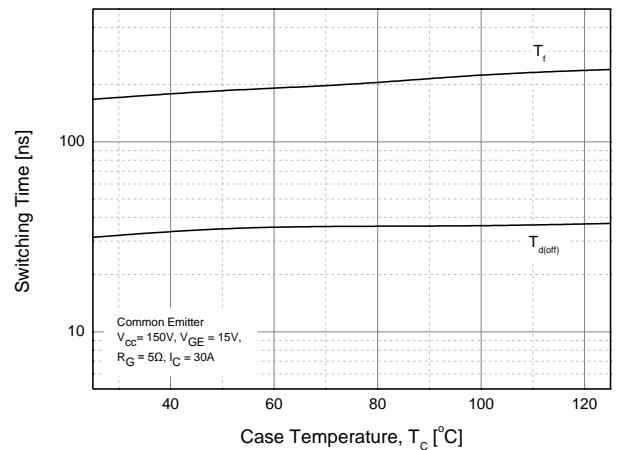


Fig. 13 Gate charge characteristics

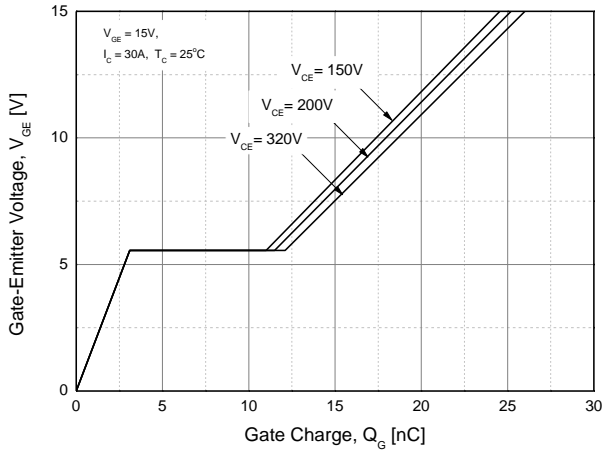


Fig. 14 SOA

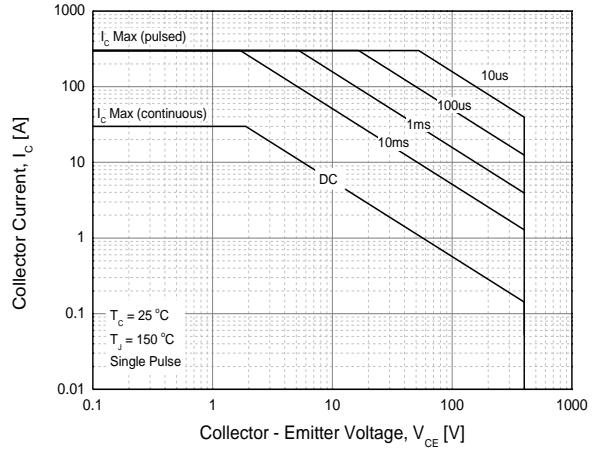


Fig. 15 RBSOA

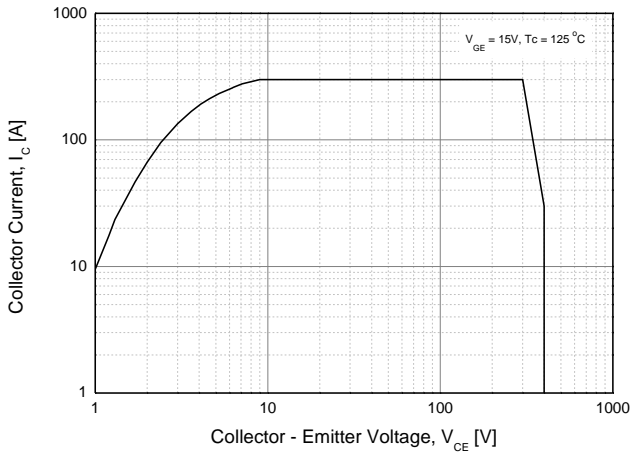
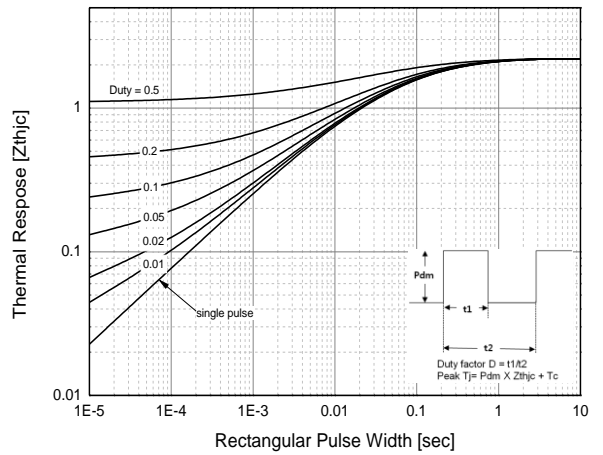
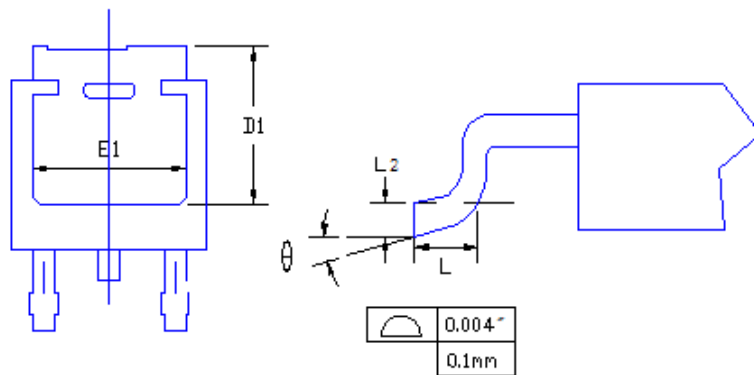
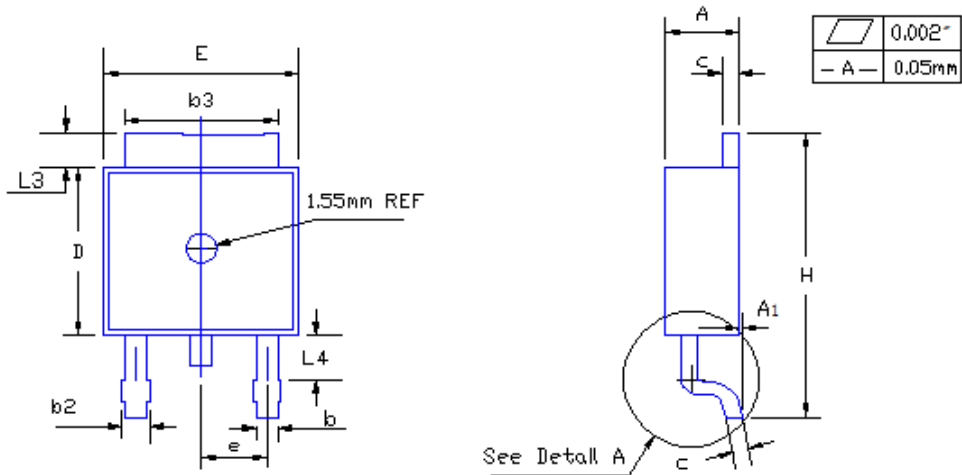


Fig. 16 Transient thermal impedance



**TO-252 (D-PAK) MECHANICAL DATA**



SYMBOL	MILLIMETERS	
	MIN	MAX
A	2.19	2.38
A1	—	0.13
b	0.64	0.89
b2	0.84	1.14
b3	5.21	5.46
c	0.46	0.61
D	5.97	6.22
D1	5.21	—
E	6.35	6.73
E1	4.83	—
e	2.29BSC	
H	9.65	10.41
L	1.40	1.78
L2	0.51BSC	
L3	0.89	1.27
L4	0.64	1.01
Ø	0	8